



60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C (Note 5)
	4.1mΩ @ V _G S = 10V	100A
60V	6.3mΩ @ V _{GS} = 6V	81A
	7mΩ @ V _{GS} = 4.5V	77A

Features and Benefits

- 100% Unclamped Inductive Switching (UIS) Test in Production –
 Ensures More Reliable and Robust End Application
- Low Rds(ON) Ensures On-State Losses are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

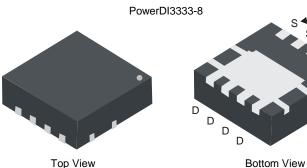
Description and Applications

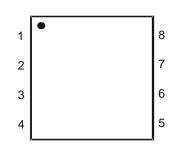
This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

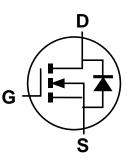
- Synchronous rectification
- Motor controls
- DC-DC converters
- Power management

Mechanical Data

- Package: PowerDI[®]3333-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (€3)
- Weight: 0.034 grams (Approximate)







Bottom View

Top View Equivalent Circuit

Ordering Information (Note 4)

Part Number	Package	Pac	king
Fait Number	Fackage	Qty.	Carrier
DMT6005LFG-7	PowerDI3333-8	2,000	Tape & Reel
DMT6005LFG-13	PowerDI3333-8	3,000	Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/
- Limited by package.



Marking Information

Site 1:



SK6 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 24 = 2024) WW = Week Code (01 to 53)

Site 2:



SK6 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 4 = 2024) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

Year	2018	-	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	8	-	4	5	6	7	8	9	0	1	2	3
Week 1-26				27-52 53								
Code	Code A-Z			a-z			z					
Internal Code	Sun Mon			Tue	W	ed	Thu		Fri		Sat	
Code	Т		U		V	V	V	Х		Υ		Z

Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	60	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current (Notes 5 & 6) V _{GS} = 10V	T _C = +25°C T _C = +70°C	lo	100 80	А
Continuous Drain Current (Note 7) $V_{GS} = 10V$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		lo	18 14	А
Maximum Continuous Body Diode Forward Current (Note 6)	Is	100	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	400	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle =	Ism	400	Α	
Avalanche Current, L = 1mH	I _{AS}	18.5	Α	
Avalanche Energy, L = 1mH	Eas	171	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 7)	T _A = +25°C	PD	1.98	W
Thermal Resistance, Junction to Ambient (Note 7)	Reja	63	°C/W	
Total Power Dissipation (Note 6)	PD	62.5	W	
Thermal Resistance, Junction to Case (Note 6)	R ₀ JC	2.0	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

Notes:

- 5. Limited by package.
- 6. Thermal pediagon.7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



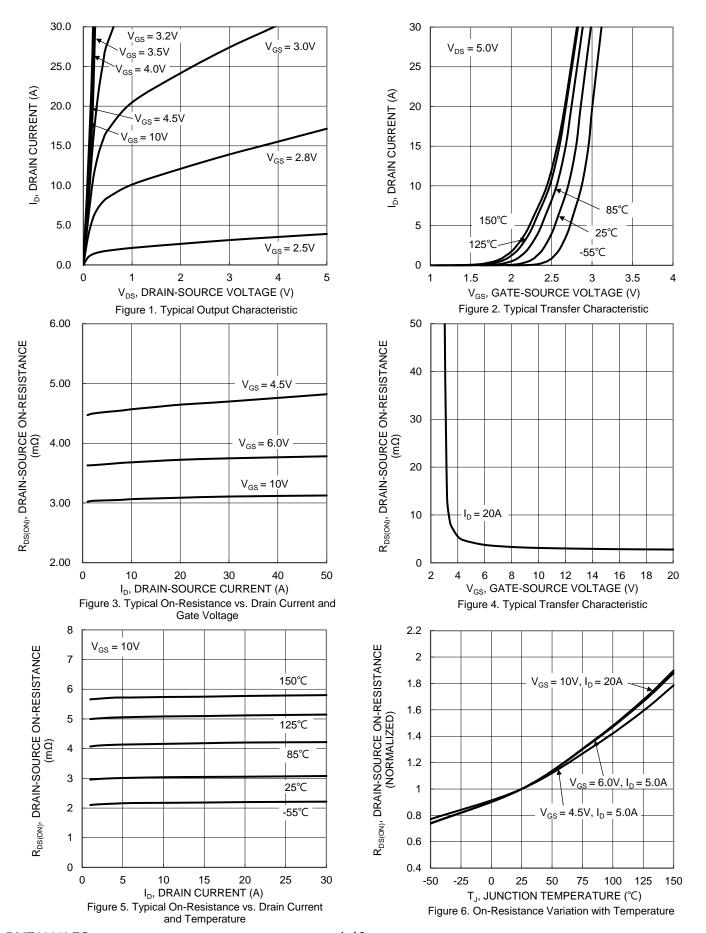
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	VGS = 0V, ID = 1mA		
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 48V, V _{GS} = 0V		
Gate-Source Leakage	Igss		_	±100	nA	V _G S = ±20V, V _D S = 0V		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	VGS(TH)	1	_	2.5	V	V _{DS} = V _{GS} , I _D = 250μA		
		_	3.1	4.1	mΩ	V _{GS} = 10V, I _D = 20A		
Static Drain-Source On-Resistance	R _{DS(ON)}		3.6	6.3	mΩ	V _{GS} = 6V, I _D = 20A		
		_	4.4	7	mΩ	Vgs = 4.5V, ID = 20A		
Diode Forward Voltage	VsD	_	0.8	1.2	V	V _G S = 0V, I _S = 20A		
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance	Ciss	_	3150	_		V _{DS} = 30V, V _{GS} = 0V f = 1MHz		
Output Capacitance	Coss		1036	_	pF			
Reverse Transfer Capacitance	Crss	_	69	_				
Gate Resistance	Rg	_	0.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge (V _{GS} = 10V)	Qg	_	48.7	_				
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	23.6	_	nC	\/ 20\/ I- 50A		
Gate-Source Charge	Qgs	_	7.0	_	nc	$V_{DD} = 30V, I_{D} = 50A$		
Gate-Drain Charge	Q _{gd}	_	11.2	_				
Turn-On Delay Time	td(on)	_	7.3	_				
Turn-On Rise Time	t _R	_	11.3	_		V _{DD} = 30V, V _{GS} = 10V		
Turn-Off Delay Time	t _{D(OFF)}	_	26.0	_	ns	$I_D=30A,\ R_g=3.3\Omega$		
Turn-Off Fall Time	tF	_	11.0	_				
Body Diode Reverse Recovery Time	trr	_	40.8	_	ns	L 200 di/dt 4000//		
Body Diode Reverse Recovery Charge	Q _{RR}	_	51.5	_	nC	I _F = 30A, di/dt = 100A/μs		

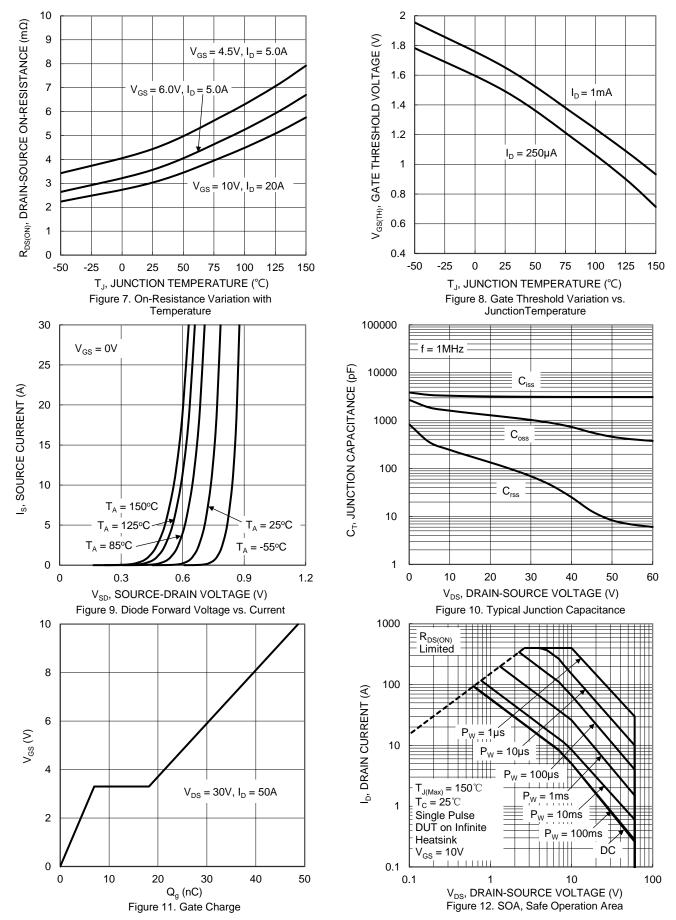
Notes:

^{8.} Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.











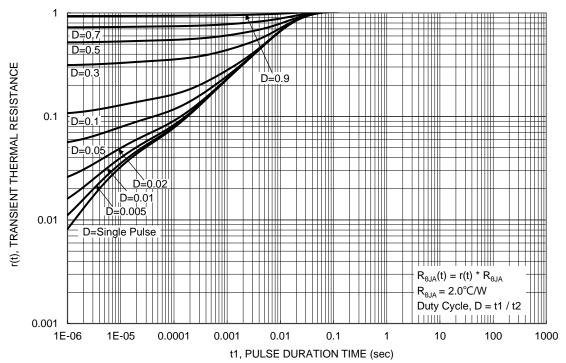


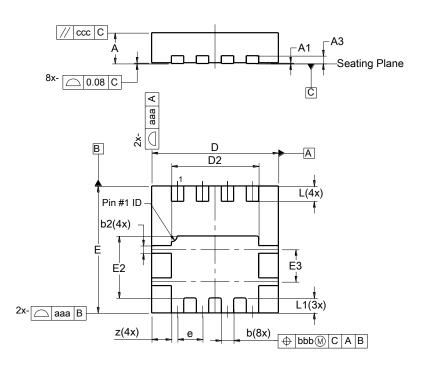
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

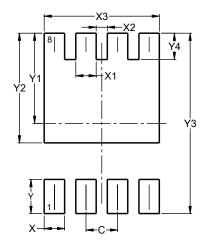


	PowerDI3333-8							
Dim	Min	Max	Тур					
Α	0.75	0.85	0.80					
A1	0.00	0.05	0.02					
А3	-	_	0.203					
b	0.27	0.37	0.32					
b2	-	_	0.20					
D	3.25	3.35	3.30					
D2	2.22	2.32	2.27					
Е	3.25	3.35	3.30					
E2	1.56	1.66	1.61					
E3	0.79	0.89	0.84					
е	1	-	0.65					
L	0.35	0.45	0.40					
L1	_	_	0.39					
z	0.515							
aaa	0.25							
bbb	0.10							
CCC	0.10							
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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